





ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
<b>INPUT</b>					
Reverse voltage			V <sub>R</sub>	6	V
Forward current			I <sub>F</sub>	60	mA
Surge current			I <sub>FSM</sub>	2.5	A
Power dissipation			P <sub>diss</sub>	100	mW
Derate from 25 °C				1.33	mW/°C
<b>OUTPUT</b>					
Peak off-state voltage		VO4154D/H/M	V <sub>DRM</sub>	400	V
		VO4156D/H/M	V <sub>DRM</sub>	600	V
RMS on-state current			I <sub>TM</sub>	300	mA
Total power dissipation			P <sub>diss</sub>	500	mW
Derate from 25 °C				6.6	mW/°C
<b>COUPLER</b>					
Isolation test voltage (between emitter and detector, climate per DIN 500414, part 2, Nov. 74)	t = 1 min		V <sub>ISO</sub>	5300	V <sub>RMS</sub>
Storage temperature range			T <sub>stg</sub>	- 55 to + 150	°C
Ambient temperature range			T <sub>amb</sub>	- 55 to + 100	°C
Soldering temperature	max. ≤ 10 s dip soldering ≥ 0.5 mm from case bottom		T <sub>sld</sub>	260	°C

**Note**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.



Fig. 1 - Recommended Operating Condition

THERMAL CHARACTERISTICS				
PARAMETER	SYMBOL	VALUE	UNIT	
LED power dissipation	$P_{diss}$	100	mW	
Output power dissipation	$P_{diss}$	500	mW	
Maximum LED junction temperature	$T_{jmax.}$	125	°C	
Maximum output die junction temperature	$T_{jmax.}$	125	°C	
Thermal resistance, junction emitter to board	$\theta_{JEB}$	150	°C/W	
Thermal resistance, junction emitter to case	$\theta_{JEC}$	139	°C/W	
Thermal resistance, junction detector to board	$\theta_{JDB}$	78	°C/W	
Thermal resistance, junction detector to case	$\theta_{JDC}$	103	°C/W	
Thermal resistance, junction emitter to junction detector	$\theta_{JED}$	496	°C/W	
Thermal resistance, case to ambient	$\theta_{CA}$	3563	°C/W	

**Note**

- The thermal characteristics table above were measured at 25 °C and the thermal model is represented in the thermal network below. Each resistance value given in this model can be used to calculate the temperatures at each node for a given operating condition. The thermal resistance from board to ambient will be dependent on the type of PCB, layout and thickness of copper traces. For a detailed explanation of the thermal model, please reference Vishay's Thermal Characteristics of Optocouplers application note.

ELECTRICAL CHARACTERISTICS ( $T_{amb} = 25\text{ °C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>							
Forward voltage	$I_F = 10\text{ mA}$		$V_F$		1.2	1.4	V
Reverse current	$V_R = 6\text{ V}$		$I_R$		0.1	10	$\mu\text{A}$
Input capacitance	$V_F = 0\text{ V}$ , $f = 1\text{ MHz}$		$C_I$		25		pF
<b>OUTPUT</b>							
Repetitive peak off-state voltage	$I_{DRM} = 100\text{ }\mu\text{A}$	VO4154D/H/M	$V_{DRM}$	400			V
		VO4156D/H/M	$V_{DRM}$	600			V
Off-state current	$V_D = V_{DRM}$ , $I_F = 0\text{ A}$		$I_{DRM}$			100	$\mu\text{A}$
On-state voltage	$I_T = 300\text{ mA}$		$V_{TM}$			3	V
On-state current	$PF = 1$ , $V_{T(RMS)} = 1.7\text{ V}$		$I_{TM}$			300	mA
Off-state current in inhibit state	$I_F = 2\text{ mA}$ , $V_{DRM}$		$I_{DINH}$			200	$\mu\text{A}$
Holding current			$I_H$			500	$\mu\text{A}$
Zero cross inhibit voltage	$I_F = \text{rated } I_{FT}$		$V_{IH}$			20	V
Critical rate of rise of off-state voltage	$V_D = 0.67 V_{DRM}$ , $T_J = 25\text{ °C}$		$dV/dt_{cr}$	5000			V/ $\mu\text{s}$
Critical rate of rise of on-state			$dV/dt_{cr}$	8			A/ $\mu\text{s}$
<b>COUPLER</b>							
LED trigger current, current required to latch output	$V_D = 3\text{ V}$	VO4154D	$I_{FT}$			1.6	mA
		VO4154H	$I_{FT}$			2	mA
		VO4154M	$I_{FT}$			3	mA
		VO4156D	$I_{FT}$			1.6	mA
		VO4156H	$I_{FT}$			2	mA
		VO4156M	$I_{FT}$			3	mA
Common mode coupling capacitance			$C_{CM}$		0.01		pF
Capacitance (input to output)	$f = 1\text{ MHz}$ , $V_{IO} = 0\text{ V}$		$C_{IO}$		0.8		pF

**Note**

- Minimum and maximum values were tested requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.



SAFETY AND INSULATION RATINGS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Climatic classification (according to IEC68 part 1)				55/100/21		
Pollution degree (DIN VDE 0109)				2		
Comparative tracking index per DIN IEC112/VDE 0303 part 1, group IIIa per DIN VDE 6110 175 399			175		399	
$V_{IOTM}$		$V_{IOTM}$	8000			V
$V_{IORM}$		$V_{IORM}$	890			V
$P_{SO}$		$P_{SO}$			500	mW
$I_{SI}$		$I_{SI}$			250	mA
$T_{SI}$		$T_{SI}$			175	°C
Creepage distance			7			mm
Clearance distance			7			mm

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ °C}$ , unless otherwise specified)



Fig. 2 - Diode Forward Voltage vs. Forward Current



Fig. 4 - Leakage Current vs. Ambient Temperature

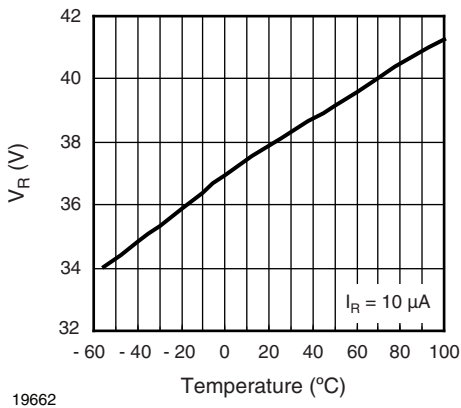


Fig. 3 - Diode Reverse Voltage vs. Temperature



Fig. 5 - On-State Current vs. On-State Voltage



20009

Fig. 6 - Output Off Current (Leakage) vs. Voltage



20011

Fig. 9 - Normalized Holding Current vs. Temperature



19666

Fig. 7 - Normalized Trigger Input Current vs. Temperature



20012

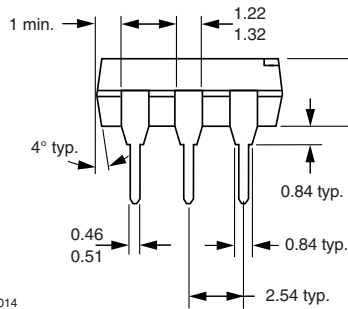
Fig. 10 -  $I_{FT}$  vs. LED Pulse Width



20010

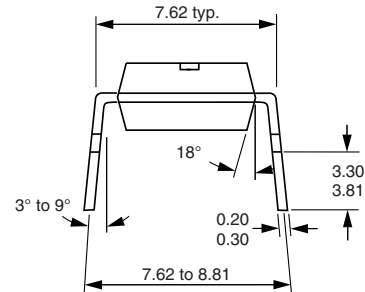
Fig. 8 -  $I_{FT}$  (mA) vs. Turn-On Time ( $\mu$ s)

**PACKAGE DIMENSIONS** in millimeters



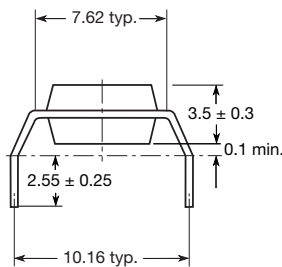
i178014

**Option 6**

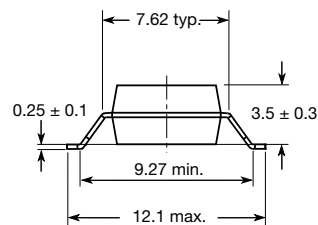
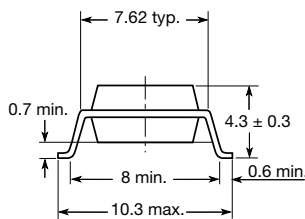


**Option 7**

**Option 8**



20802-41



**PACKAGE MARKING** (example)



**Notes**

- Only options 1, 7, and 8 are reflected in the package marking.
- The VDE Logo is only marked on option 1 parts.
- Tape and reel suffix (T) is not part of the package marking.



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

## Material Category Policy

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.**

**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.**

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)